

**SN54ABT162245, SN74ABT162245
16-BIT BUS TRANSCEIVERS
WITH 3-STATE OUTPUTS**

MARCH 1993

- A-Port Outputs Have Equivalent $25\text{-}\Omega$ Series Resistors, So No External Resistors Are Required
- Members of the Texas Instruments *Widebus™ Family*
- State-of-the-Art *EPIC-IIIB™ BiCMOS Design* Significantly Reduces Power Dissipation
- Latch-Up Performance Exceeds 500 mA Per JEDEC Standard JESD-17
- Typical V_{OLP} (Output Ground Bounce) < 1 V at $V_{CC} = 5$ V, $T_A = 25^\circ\text{C}$
- Distributed V_{CC} and GND Pin Configuration Minimizes High-Speed Switching Noise
- Flow-Through Architecture Optimizes PCB Layout
- Packaged in Plastic 300-mil Shrink Small-Outline and Thin Shrink Small-Outline Packages and 380-mil Fine-Pitch Ceramic Flat Packages Using 25-mil Center-to-Center Spacings

description

The 'ABT162245 is a 16-bit (dual-octal) noninverting 3-state transceiver designed for synchronous two-way communication between data buses. The control function implementation minimizes external timing requirements.

This device can be used as two 8-bit transceivers or one 16-bit transceiver. It allows data transmission from the A bus to the B bus or from the B bus to the A bus depending upon the logic level at the direction-control (DIR) input. The output-enable (\overline{OE}) input can be used to disable the device so that the buses are effectively isolated.

The A-port outputs, which are designed to source or sink up to 12 mA, include $25\text{-}\Omega$ series resistors to reduce overshoot and undershoot.

To ensure the high-impedance state during power up or power down, \overline{OE} should be tied to V_{CC} through a pullup resistor; the minimum value of the resistor is determined by the current-sinking capability of the driver.

The SN74ABT162245 is available in TI's shrink small-outline package (DL), which provides twice the I/O pin count and functionality of standard small-outline packages in the same printed-circuit-board area.

The SN54ABT162245 is characterized for operation over the full military temperature range of -55°C to 125°C . The SN74ABT162245 is characterized for operation from -40°C to 85°C .

FUNCTION TABLE
(each 8-bit section)

INPUTS		OPERATION
\overline{OE}	DIR	
L	L	B data to A bus
L	H	A data to B bus
H	X	Isolation

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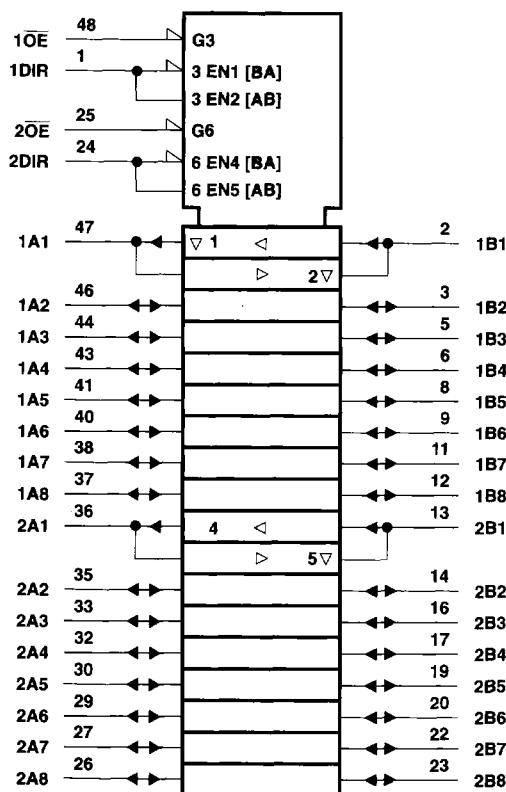
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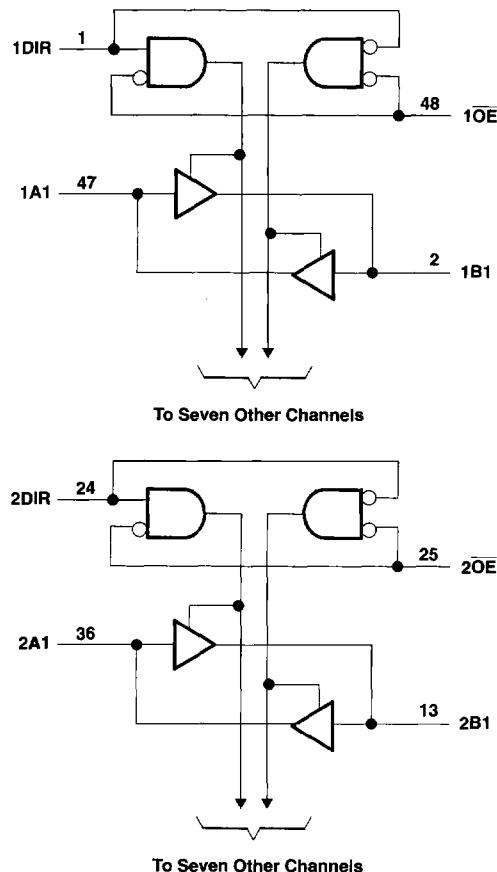
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logic symbol†



logic diagram (positive logic)



† This symbol is in accordance with ANSI/IEEE Std 91-1984
and IEC Publication 617-12.

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)‡

Supply voltage range, V_{CC}	-0.5 V to 7 V
Input voltage range, V_I (except I/O ports) (see Note 1)	-0.5 V to 7 V
Voltage range applied to any output in the high state or power-off state, V_O	-0.5 V to 5.5 V
Current into any output in the low state, I_O :	SN54ABT162245 (B port)	96 mA
	SN74ABT162245 (B port)	128 mA
	A port	30 mA
Input clamp current, I_{IK} ($V_I < 0$)	-18 mA
Output clamp current, I_{OK} ($V_O < 0$)	-50 mA
Maximum power dissipation at $T_A = 55^\circ\text{C}$ (in still air): DGG package	0.8 W	
	DL package	0.85 W
Storage temperature range	-65°C to 150°C

‡ Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTE 1: The input and output negative-voltage ratings may be exceeded if the input and output clamp-current ratings are observed.



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recommended operating conditions (see Note 2)

		SN54ABT162245		SN74ABT162245		UNIT
		MIN	MAX	MIN	MAX	
V _{CC}	Supply voltage	4.5	5.5	4.5	5.5	V
V _{IH}	High-level input voltage	2		2		V
V _{IL}	Low-level input voltage			0.8		V
V _I	Input voltage	0	V _{CC}	0	V _{CC}	V
I _{OH}	High-level output current	B port		-24	-32	mA
		A port		-12	-12	
I _{OL}	Low-level output current	B port		48	64	mA
		A port		12	12	
Δt/Δv	Input transition rise or fall rate	Outputs enabled		10	10	ns/V
T _A	Operating free-air temperature			-55	125	-40 85 °C

NOTE 2: Unused or floating pins (input or I/O) must be held high or low.

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electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER	TEST CONDITIONS	$T_A = 25^\circ\text{C}$			SN54ABT162245		SN74ABT162245		UNIT
		MIN	TYP†	MAX	MIN	MAX	MIN	MAX	
V_{IK}	$V_{CC} = 4.5 \text{ V}, I_I = -18 \text{ mA}$			-1.2	-1.2		-1.2		V
V_{OH}	$V_{CC} = 4.5 \text{ V}, I_{OH} = -3 \text{ mA}$	B port	2.5		2.5		2.5		V
	$V_{CC} = 5 \text{ V}, I_{OH} = -3 \text{ mA}$		3		3		3		
	$V_{CC} = 4.5 \text{ V}, I_{OH} = -24 \text{ mA}$		2		2				
	$V_{CC} = 4.5 \text{ V}, I_{OH} = -32 \text{ mA}$		2‡				2		
	$V_{CC} = 4.5 \text{ V}, I_{OH} = -12 \text{ mA}$	A port	2.6‡				2.6		
V_{OL}	$V_{CC} = 4.5 \text{ V}$	A port	0.4	0.8	0.8		0.65		V
							0.8		
		B port		0.55	0.55				
				0.55‡			0.55		
I_I	$V_{CC} = 5.5 \text{ V}, V_I = V_{CC} \text{ or GND}$	Control inputs		±1	±1	±1			μA
		A or B ports		±100	±100	±100			
$I_{OZH}^§$	$V_{CC} = 5.5 \text{ V}, V_O = 2.7 \text{ V}$			50	50	50			μA
$I_{OZL}^§$	$V_{CC} = 5.5 \text{ V}, V_O = 0.5 \text{ V}$			-50	-50	-50			μA
I_{off}	$V_{CC} = 0, V_I \text{ or } V_O \leq 4.5 \text{ V}$			±100			±100		μA
I_{CEX}	$V_{CC} = 5.5 \text{ V}, V_O = 5.5 \text{ V}$	Outputs high		50	50	50			μA
$I_O^¶$	$V_{CC} = 5.5 \text{ V}, V_O = 2.5 \text{ V}$		-50 -100 -180	-50 -180	-50 -180	-50 -180			mA
I_{CC}	$V_{CC} = 5.5 \text{ V}, I_O = 0, V_I = V_{CC} \text{ or GND}$	A or B ports	Outputs high		2	2	2		mA
			Outputs low		32	32	32		
			Outputs disabled		2	2	2		
$\Delta I_{CC}^#$	$V_{CC} = 5.5 \text{ V}, \text{One input at } 3.4 \text{ V, Other inputs at } V_{CC} \text{ or GND}$	Data inputs	Outputs enabled		1	1.5	1		mA
			Outputs disabled		0.05	1	0.05		
		Control inputs			1.5	1.5	1.5		
C_i	$V_I = 2.5 \text{ V or } 0.5 \text{ V}$			7					pF
C_{io}	$V_O = 2.5 \text{ V or } 0.5 \text{ V}$			7					pF

† All typical values are at $V_{CC} = 5 \text{ V}$.

‡ On products compliant to MIL-STD-883, Class B, this parameter does not apply.

§ The parameters I_{OZH} and I_{OZL} include the input leakage current.

¶ Not more than one output should be tested at a time, and the duration of the test should not exceed one second.

This is the increase in supply current for each input that is at the specified TTL voltage level rather than V_{CC} or GND.